

Title (en)
Hotplate device

Title (de)
Kochfeldvorrichtung

Title (fr)
Dispositif de plate de cuisson

Publication
EP 2703728 B2 20231108 (DE)

Application
EP 13182240 A 20130829

Priority
• ES 201231365 A 20120903
• EP 13382039 A 20130208
• EP 13182240 A 20130829

Abstract (en)
[origin: EP2704523A2] The device has variable cooking surface areas (12a) which is provided with user interfaces (14a) according to the input and output portions of cooking surface area parameters, such that user interface are strip-shaped. The user interface of the variable cooking surface area is extended over the entire cooking surface of the longitudinal extension (16a). The operator interface portion is associated with each of the variable cooking surface areas. An independent claim is included for method for operating cook device.

IPC 8 full level
F24C 7/08 (2006.01); **H05B 3/74** (2006.01); **H05B 6/06** (2006.01)

CPC (source: EP)
F24C 7/083 (2013.01); **H05B 6/062** (2013.01); **H05B 2213/03** (2013.01); **H05B 2213/07** (2013.01)

Citation (opposition)
Opponent :
• EP 2395813 A1 20111214 - SAMSUNG ELECTRONICS CO LTD [KR]
• EP 2330355 A1 20110608 - INDESIT CO SPA [IT]
• JP 2001153771 A 20010608 - ORGANO KK
• JP 2009238613 A 20091015 - MITSUBISHI ELECTRIC CORP, et al

Cited by
DE102016223849B3; DE102016223848A1; DE102015104350A1; DE102015104350B4; EP3330616A3; EP3330617A1; EP3028535B1; EP3028535B2

Designated contracting state (EPC)
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)
EP 2704523 A2 20140305; EP 2704523 A3 20150624; EP 2704523 B1 20161214; EP 2704523 B2 20191218; EP 2703728 A1 20140305; EP 2703728 B1 20180822; EP 2703728 B2 20231108

DOCDB simple family (application)
EP 13182251 A 20130829; EP 13182240 A 20130829